

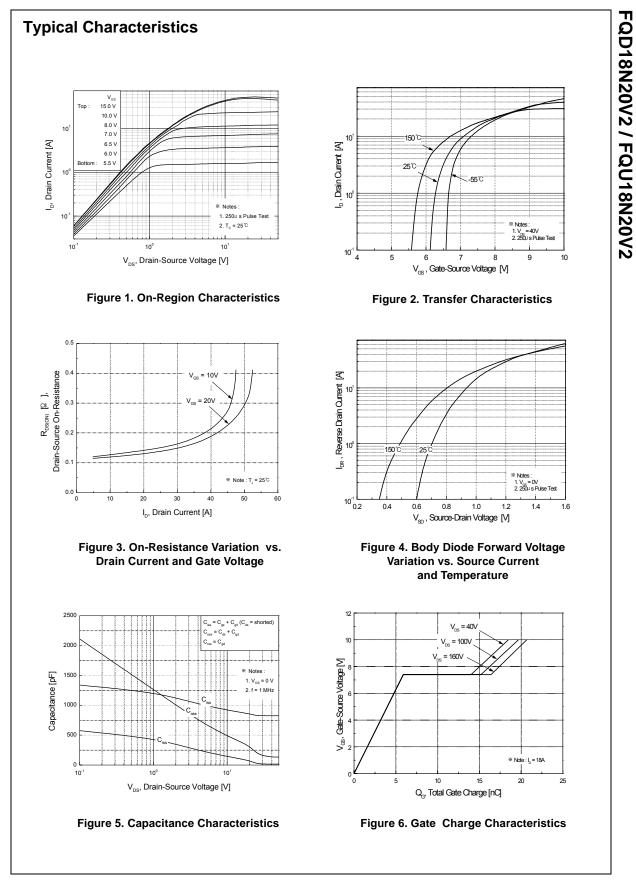
Symbol	Parameter		FQD18N20V2 / FQU18N20V2	Units
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		15	А
	- Continuous (T _C = 100°C)		9.75	А
I _{DM}	Drain Current - Pulsed	(Note 1)	60	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	340	mJ
I _{AR}	Avalanche Current	(Note 1)	15	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	8.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.5	V/ns
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		2.5	W
	Power Dissipation ($T_C = 25^{\circ}C$)		83	W
	- Derate above 25°C		0.67	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

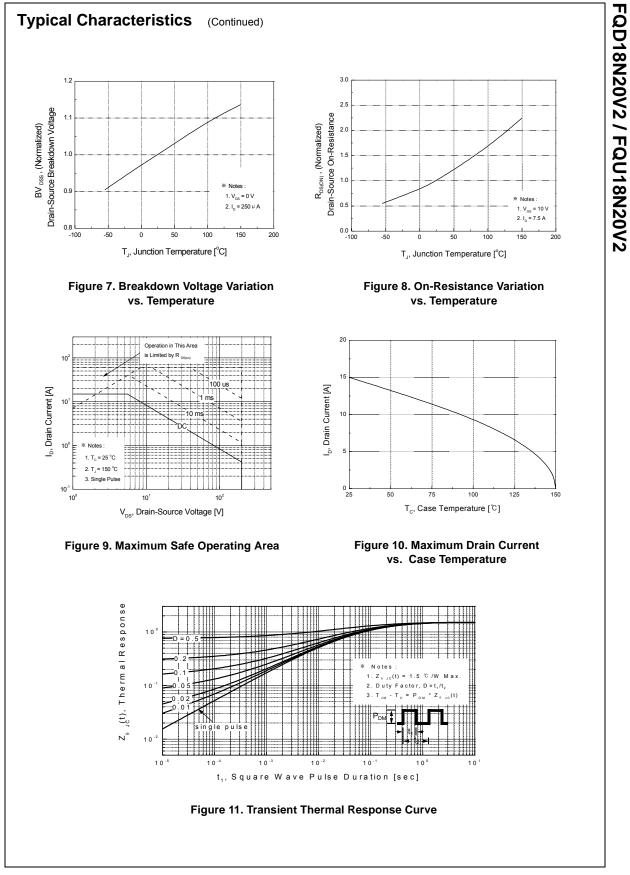
Thermal Characteristics

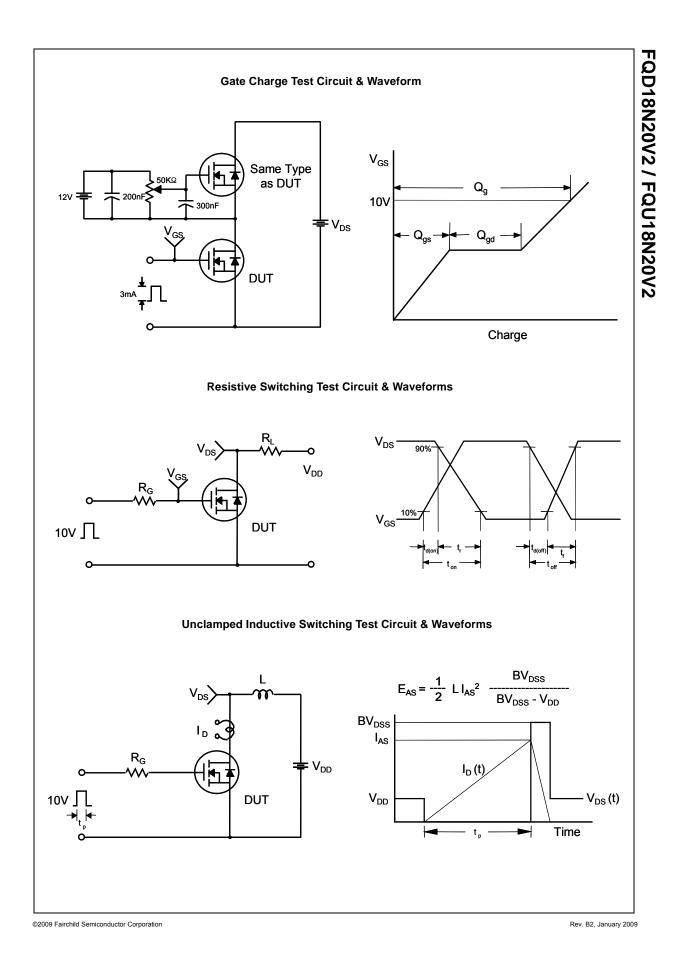
Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.5	°C/W
R _{0JA} Thermal Resistance, Junction-to-Ambient *			50	°C/W
R _{0JA} Thermal Resistance, Junction-to-Ambient			110	°C/W

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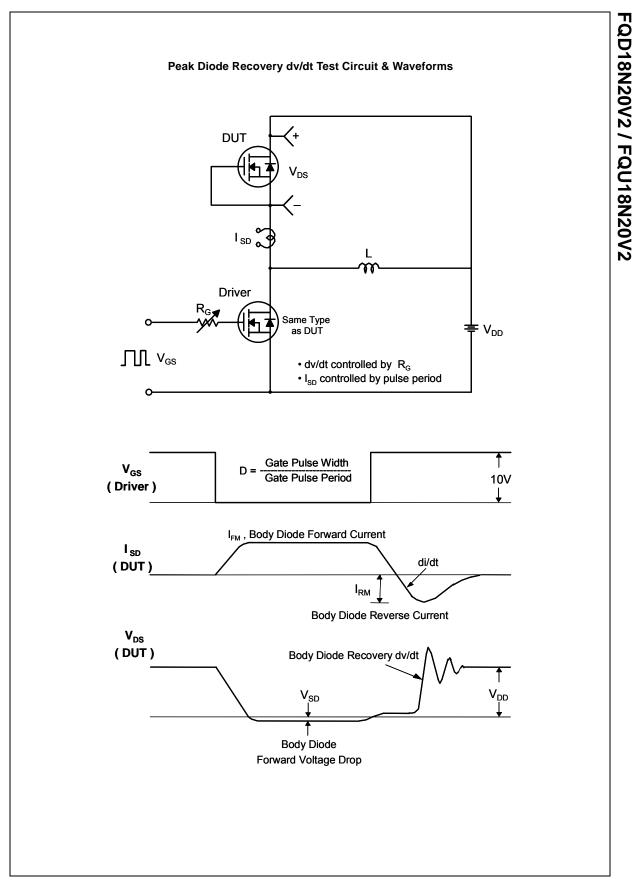
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	200			V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C		0.25		V/°C
I _{DSS}		V _{DS} = 200 V, V _{GS} = 0 V			1	μA
	Zero Gate Voltage Drain Current	$V_{DS} = 160 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
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	aracteristics				1	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 7.5 A		0.12	0.14	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}$ (Note 4)		11		S
95	r ofward Halloconductance					Ŭ
Dynam	ic Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		830	1080	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		200	260	pF
C _{rss}	Reverse Transfer Capacitance	*		25	33	pF
C _{oss}	Output Capacitance	V _{DS} = 160 V, V _{GS} = 0 V, f = 1.0 MHz		70		pF
C _{oss} eff.	Effective Output Capacitance	V_{DS} = 0V to 160 V, V_{GS} = 0 V		135		pF
Switch	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 100 V, I _D = 18 A,		16	40	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$		133	275	ns
t _{d(off)}	Turn-Off Delay Time			38	85	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		62	135	ns
Qg	Total Gate Charge	V _{DS} = 160 V, I _D = 18 A,		20	26	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		5.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		10		nC
Drain-S	Source Diode Characteristics ar	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Dic				15	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	Forward Current			60	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 15 A			1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 18 A,		158		ns
Q _{rr}	Reverse Recovery Charge	$dI_{\rm F} / dt = 100 \text{ A}/\mu \text{s}$ (Note 4)		1.0		μC
L = 1.58mH	$ \begin{array}{l} \mbox{tating: Pulse width limited by maximum junction temper} \\ , \ l_{AS} = 18A, \ V_{DD} = 50V, \ R_{G} = 25 \ \Omega, \ Starting \ T_{J} = 25^{\circ}C \\ \ di'dt \leq 200A/\mu s, \ V_{DD} \leq BV_{DSS}, \ Starting \ T_{J} = 25^{\circ}C \\ \ Pulse width \leq 300\mu s, \ Duty \ cycle \leq 2\% \\ \end{array} $	ature				

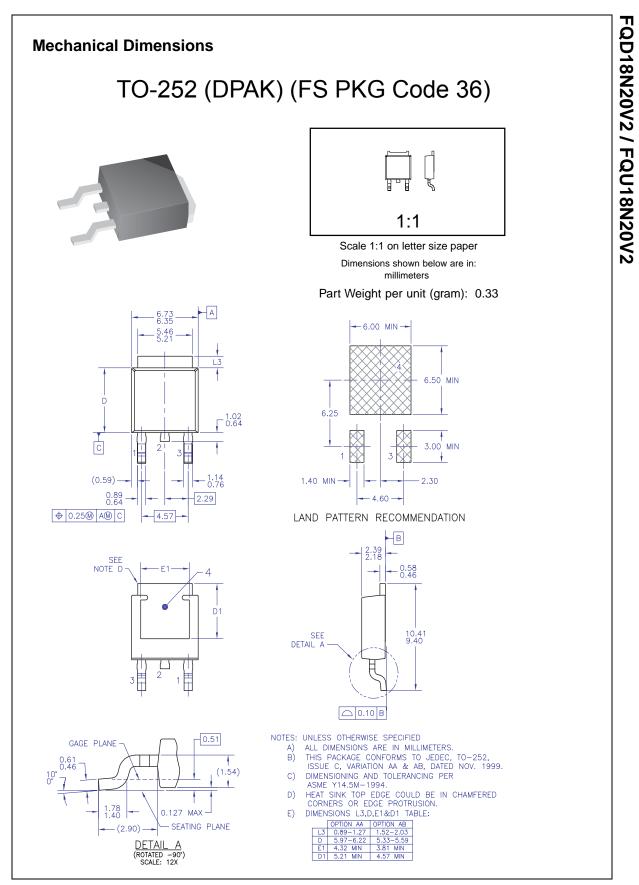


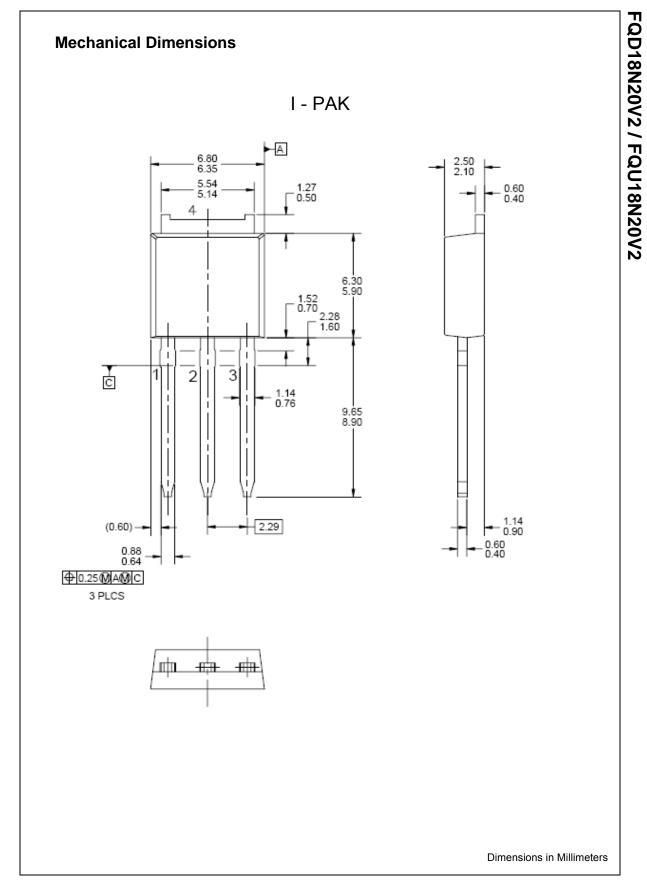




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